



Product Change Notification

113578 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113578 - 00
Change Title: Intel® Server System R1304JP4OC
PCN 113578-00, Product Design
Add Mylar and a Plastic Block
Date of Publication: January 14, 2015

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

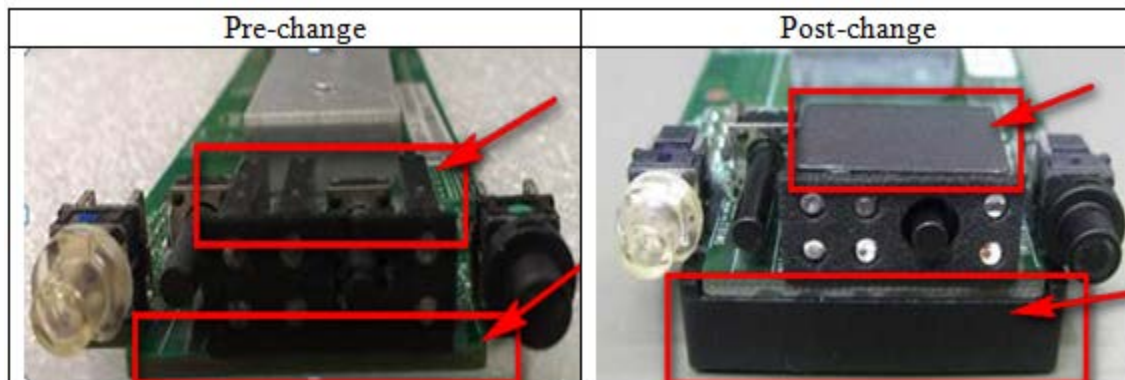
Date Customer Must be Ready to Receive Post-Conversion Material:	January 29, 2015
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Description of Change to the Customer:

** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Intel is implementing the following change on the Intel® Server System R1304JP4OC:

- Add a Mylar on the top of the front panel board and add a plastic block for the front end under the front panel board to hold parts more securely. See the images below:



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1304JP4OC	923165	G76215-002	G76215-003

PCN Revision History:

Date of Revision:

January 14, 2015

Revision Number:

00

Reason:

Originally Published PCN